

# WINSTAR Display

## OLED SPECIFICATION

Model No:

***WEP012864UWPP3D00000***

# SPECIFICATION

Version: C

CUSTOMER :

MODULE NO. : WEP012864UWPP3D00000

**APPROVED BY:**

( FOR CUSTOMER USE ONLY )

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY
RELEASE DATE:			

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☐ APPROVAL FOR SPECIFICATIONS AND SAMPLE

**MODEL NO :**

RECORDS OF REVISION			DOC. FIRST ISSUE
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2021/05/21		First release
A	2021/10/27		Modify OLED Lifetime Conditions Description
B	2021/11/01		Add Gray Scale Description
C	2021/12/16		Modify PIN 4 Interface Pin Function & Initial code Description

# Contents

- 1.Module Classification Information
- 2.General Specification
- 3.Contour Drawing & Block Diagram
- 4.Interface Pin Function
- 5.Absolute Maximum Ratings
- 6.Electrical Characteristics
- 7.Optical Characteristics
- 8.OLED Lifetime
- 9.Reliability
- 10.Inspection specification
- 11.Precautions in use of OLED Modules

# 1.Module Classification Information

W E P 012864 U W P P 3 D 0 0 0 00  
 ① ② ③ ④ ⑤ ⑥ ⑦ ⑧ ⑨ ⑩ ⑪ ⑫ ⑬ ⑭

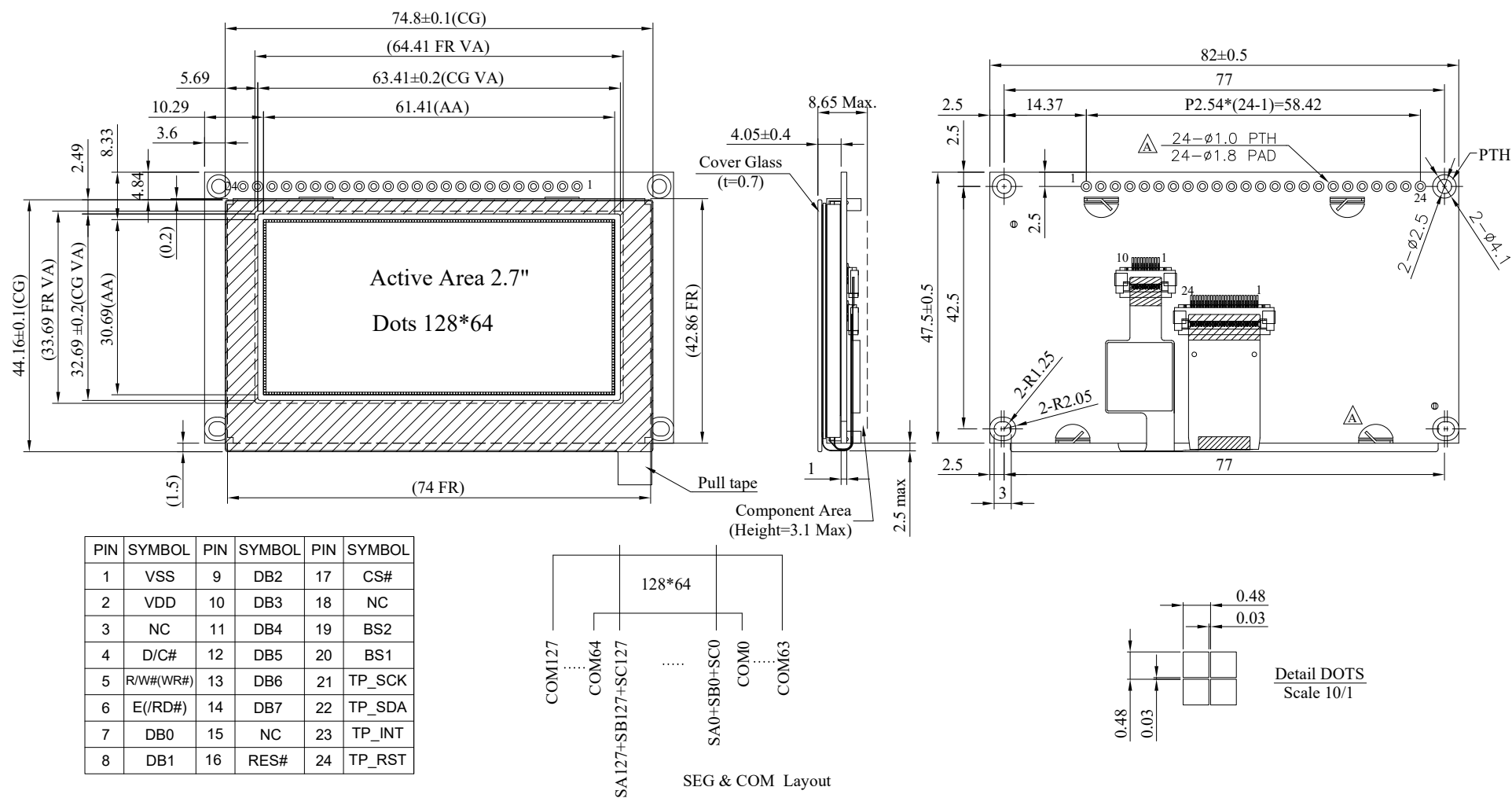
1	Brand : WINSTAR DISPLAY CORPORATION				
2	E : OLED				
3	Display Type	H : COB Character	G : COB Graphic		
		O : COG	F : COG + FR		
		P : COG + FR + PCB	X : COF		
		A : COG + PCB	N : COF + FR + PCB		
4	Dot Matrix : 128 * 64				
5	Serials code				
6	Emitting Color	A : Amber	R : Red	C : Full Color	
		B : Blue	W : White		
		G : Green	L : Yellow		
		S : Sky Blue	X : Dual Color		
7	Polarizer	P : With Polarizer; N: Without Polarizer A : Anti-glare Polarizer			
8	Display Mode	P : Passive Matrix ; N : Active Matrix			
9	Driver Voltage	3 : 3.0~3.3V ; 5 : 5.0V			
10	Touch Panel	N : Without touch panel; T : Resistive TP; D : DCT Attached CTP			
11	Product type	0 : Standard 1 : Daylight Readable 2 : Transparent OLED (TOLED) 3 : Flexible OLED (FOLED) 4 : OLED Lighting			
12	Inspection Grade	0 : Standard 2 : Special grade C : Automotive grade Y : Consumer grade			
13	Option	0 : Default ; D : Demo Kit ; E~P : Options ; Z : Semi-customized			
14	Serial No.	Serial number(00~99)			

## 2.General Specification

Item	Dimension	Unit
Dot Matrix	128 x 64 Dots	—
Module dimension	82.0 × 47.5 × 8.65 Max.	mm
Active Area	61.41 × 30.69	mm
Pixel Size	0.45 × 0.45	mm
Pixel Pitch	0.48 × 0.48	mm
Display Mode	Passive Matrix	
Display Color	White	
Drive Duty	1/64 Duty	
Gray Scale	4 bits	
OLED IC	SSD1357	
OLED Interface	8-bits 6800 and 8080 parallel, 4-line SPI, I2C	
Size	2.7 inch	

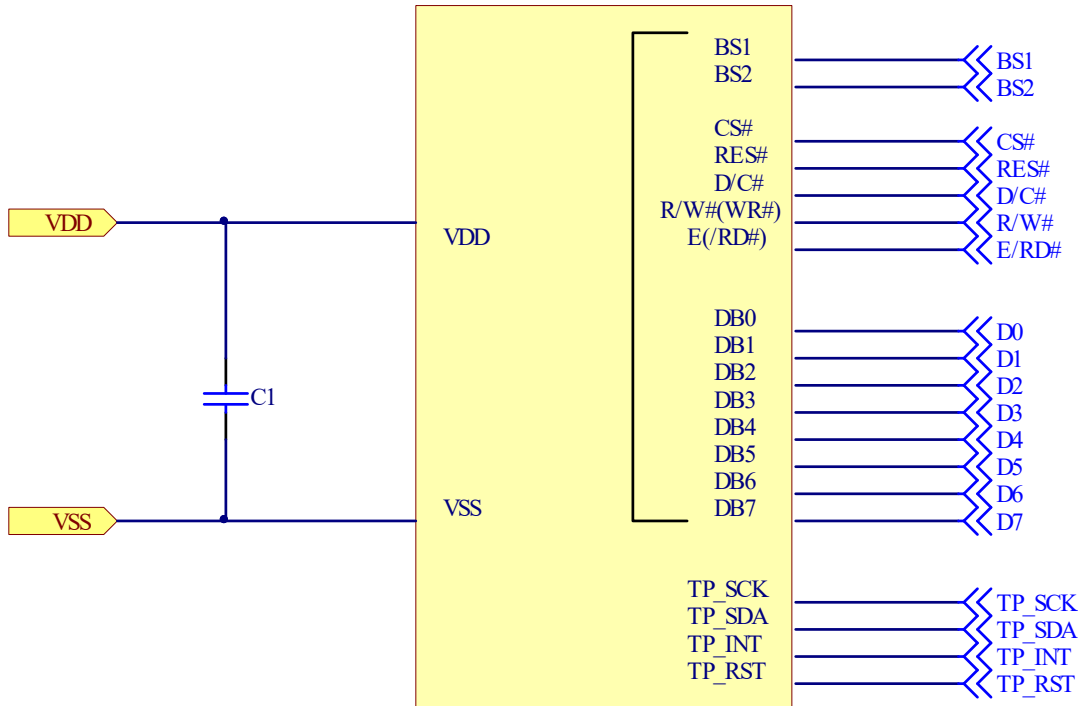
CTP IC	GT911
Detect Point	1
CTP Interface	I2C
Surface	Normal Glare

### 3. Contour Drawing & Block Diagram



The non-specified tolerance of dimension is  $\pm 0.3$  mm .

### 3.1 Application recommendations



Recommended components:

C1 : 2.2uF

OLED DISPLAY's Bus Interface selection: (Must be set the BS[2:1], refer to item 4)  
8-bits 6800 and 8080 parallel, 4-Wire SPI, I2C

Note: The capacitor value is recommended value. Select appropriate value against module application.



## 4. Interface Pin Function

No.	Symbol	Function
1	VSS	This is a ground pin.
2	VDD	Power supply pin for core logic operation
3	NC	Reserved Pin The N.C. pin between function pins is reserved for compatible and flexible design.
4	D/C#	This pin is Data/Command control pin connecting to the MCU. When the pin is pulled HIGH, the data at D[7:0] will be interpreted as data. When the pin is pulled LOW, the data at D[7:0] will be transferred to a command register. In I2C mode, this pin acts as SA0 for slave address selection.
5	R/W# (WR#)	This pin is read / write control input pin connecting to the MCU interface. When 6800 interface mode is selected, this pin will be used as Read/Write (R/W#) selection input. Read mode will be carried out when this pin is pulled HIGH and write mode when LOW. When 8080 interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled LOW and the chip is selected. When serial or I2C interface is selected, this pin must be connected to VSS.
6	E/RD#	This pin is MCU interface input. When 6800 interface mode is selected, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled HIGH and the chip is selected. When 8080 interface mode is selected, this pin receives the Read (RD#) signal. Read operation is initiated when this pin is pulled LOW and the chip is selected. When serial or I2C interface is selected, this pin must be connected to VSS.
7	DB0	These pins are bi-directional data bus connecting to the MCU data bus. Unused pins are recommended to tie LOW. When serial interface mode is selected, D0 will be the serial clock input: SCLK; D1 will be the serial data input: SDIN. When I2C mode is selected, D2, D1 should be tied together and serve as SDAout, SDAin in application and D0 is the serial clock input, SCL.
8	DB1	
9	DB2	
10	DB3	
11	DB4	
12	DB5	
13	DB6	
14	DB7	
15	NC	No connection

<b>16</b>	<b>RES#</b>	This pin is reset signal input. When the pin is pulled LOW, initialization of the chip is executed. Keep this pin pull HIGH during normal operation.		
<b>17</b>	<b>CS#</b>	Chip Select This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.		
<b>18</b>	<b>NC</b>	No connection		
<b>19</b>	<b>BS2</b>	Communicating Protocol Select.		
<b>20</b>	<b>BS1</b>	These pins are MCU interface selection input. See the following table:		
			<b>BS1</b>	<b>BS2</b>
		I2C	1	0
		4-wire Serial	0	0
		8-bit 8080 Parallel	1	1
		8-bit 6800 Parallel	0	1
<b>21</b>	<b>TP_SCK</b>	I2C clock signal		
<b>22</b>	<b>TP_SDA</b>	I2C data signal		
<b>23</b>	<b>TP_INT</b>	Interrupt signal, active low, asserted to request Host start a new transaction		
<b>24</b>	<b>TP_RST</b>	External reset signal, active low		

## 5. Absolute Maximum Ratings

Parameter	Symbol	Min	Max	Unit	Notes
Supply Voltage for Logic	VDD	-0.3	4.0	V	1, 2
Operating Temperature	TOP	-20	+70	°C	-
Storage Temperature	TSTG	-30	+80	°C	-

Note 1: All the above voltages are on the basis of “VSS = 0V”.

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6 “Electrical Characteristics”. If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

## 6. Electrical Characteristics

### 6.1 DC Electrical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
Supply Voltage for Logic	VDD	—	2.8	3.0	3.3	V
High Level Input	VIH	—	$0.8 \times VDD$	—	—	V
Low Level Input	VIL	—	—	—	$0.2 \times VDD$	V
High Level Output	VOH	—	$0.9 \times VDD$	—	—	V
Low Level Output	VOL	—	—	—	$0.1 \times VDD$	V
50% Check Board operating Current	IDD	VDD =3V	—	160	240	mA

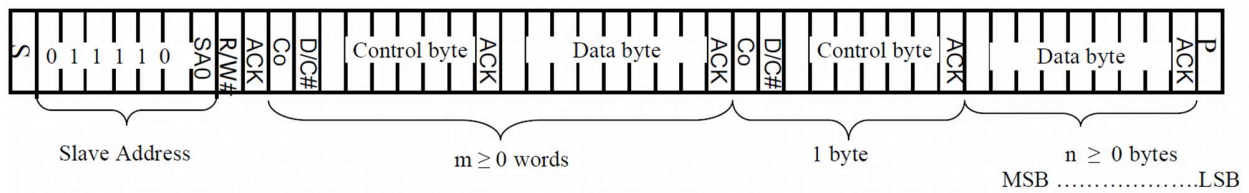
## 6.2 Initial code

```
void Initial_SSD1357(){  
  
    write_command(0xFD);           //Set Command Lock  
    write_data(0x12);             //Unlock OLED driver IC  
  
    write_command(0xAE);          //Display OFF  
  
    write_command(0xA0);          //Set Re-map/Color Depth  
    write_data(0x12);             //A[7:6] Set Color Depth,  
    write_data(0x10);             //10b: Enable Dual-COM  
  
    write_command(0xA1);          //Set Display Start Line  
    write_data(0x00);  
  
    write_command(0xA2);          //Set Display Offset  
    write_data(0x00);  
  
    write_command(0xA6);          //normal display  
  
    write_command(0xB1);          //Set Phase Length  
    write_data(0xFF);  
  
    write_command(0xB3);          //Oscillator Frequency  
    write_data(0x20);             //105Hz  
  
    write_command(0xB6);          //Set Second Pre-charge period  
    write_data(0x0F);  
  
    write_command(0xB9);  
  
    write_command(0xBB);          //Set Pre-charge voltage  
    write_data(0x1F);  
  
    write_command(0xBE);          //Set VCOMH  
    write_data(0x07);             //0.86*VCC  
  
    write_command(0xC1);          //Contrast Current  
    write_data(0x9F);             //Blue contrast set  
    write_data(0x9F);             //Green contrast set  
    write_data(0x9F);             //Red contrast set  
  
    write_command(0xCA);          //Set MUX Ratio  
    write_data(0x7F);  
  
    write_command(0xAF);          //Display on  
  
}
```

Note 1: Initial code is for reference only. Please make the best adjustment with the OLED module.

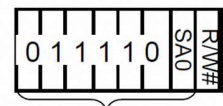
Note 2: Command: Set Contrast Control (0xC1) , This command sets the Contrast Setting of the display. The chip has 256 contrast steps from 00h to FFh. The segment output current increases as the contrast step value increases. The segment current increases, the OLED brightness increases.

## I2C-bus data format

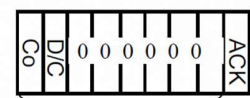


Note:

- Co – Continuation bit
- D/C# – Data / Command Selection bit
- ACK – Acknowledgement
- SA0 – Slave address bit
- R/W# – Read / Write Selection bit
- S – Start Condition / P – Stop Condition



Slave Address



Control byte

### (a) I2C address bit (SA0)

The slave address is following the start condition for recognition use. The slave address is either “b0111100” or “b0111101” by changing the SA0 to LOW or HIGH (D/C pin acts as SA0).

(b) “R/W#” bit is used to determine the operation mode of the I2C-bus interface. R/W#=1, it is in read mode. R/W#=0, it is in write mode.

(c) After the transmission of the slave address, either the control byte or the data byte may be sent across the SDA. A control byte mainly consists of Co and D/C# bits following by six “0”s.

- a. If the Co bit is set as logic “0”, the transmission of the following information will contain data bytes only.
- b. The D/C# bit determines the next data byte is acted as a command or a data. If the D/C# bit is set to logic “0”, it defines the following data byte as a command. If the D/C# bit is set to logic “1”, it defines the following data byte as a data which will be stored at the GDDRAM. The GDDRAM column address pointer will be increased by one automatically after each data write.

## 6.3 Application Note for RAM mapping

Data bus to RAM mapping under different input mode

Write data		Data bus							
Depth	Input order	D7	D6	D5	D4	D3	D2	D1	D0
Mono	-	0xFF / 0x00							
16Gray Scale	1st	X	X	D3	D2	D1	D0	X	X
	2nd	X	X	D3	D2	D1	D0	X	X
	3rd	X	X	D3	D2	D1	D0	X	X

Example code

(A) Mono

```

write_command(0xa0);
write_data(0x12);    //A[7:6] Set Color Depth,
                      //00b: mono
                      //10b: 16 Gray Scale

write_data(0x10);    //0x10: Enable Dual-COM ; 0x00 : Disable
write_command(0x15); //Column
write_data(0x00);
write_data(0x7F);
write_command(0x75); //Row
write_data(0x00);
write_data(0x3F);
write_command(0x5C);
for(y=0;y<64;y++)
{
    for(x=0;x<128;x++)
    {
        write_data(0xFF);    // or write_data(0x00);
    }
}

```

(B) 16 Gray Scale

```

write_command(0xA0);
write_data(0x92);    //A[7:6] Set Color Depth,
                      //00b: mono
                      //10b: 16 Graycale

write_data(0x10);    //0x10: Enable Dual-COM ; 0x00 : Disable
write_command(0x15); //Column
write_data(0x00);
write_data(0x7F);
write_command(0x75); //Row
write_data(0x00);
write_data(0x3F);
write_command(0x5C);
for(y=0x00;y<0x40;y++)
{
    for(x=0;x<64;x=x+4) //16 G.S.
    {
        for(z=0;z<8;z++)
        {
            write_data(x);
            write_data(x);
            write_data(x);
        }
    }
}

```

## 6.4 Command Table

(D/C# = 0, R/W#(WR#)= 0, E(RD#) = 1) unless specific setting is stated

Single byte command (D/C# = 0), Multiple byte command (D/C# = 0 for first byte, D/C# = 1 for other bytes)

Fundamental Command Table											
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0 1 1	15 A[6:0] B[6:0]	0 * *	0 A <sub>6</sub> B <sub>6</sub>	0 A <sub>5</sub> B <sub>5</sub>	1 A <sub>4</sub> B <sub>4</sub>	0 A <sub>3</sub> B <sub>3</sub>	1 A <sub>2</sub> B <sub>2</sub>	0 A <sub>1</sub> B <sub>1</sub>	1 A <sub>0</sub> B <sub>0</sub>	Set Column Address	A[6:0]: Start Address. [reset=0] B[6:0]: End Address. [reset=127] Range from 0 to 127
0 1 1	75 A[6:0] B[6:0]	0 * *	1 A <sub>6</sub> B <sub>6</sub>	1 A <sub>5</sub> B <sub>5</sub>	1 A <sub>4</sub> B <sub>4</sub>	0 A <sub>3</sub> B <sub>3</sub>	1 A <sub>2</sub> B <sub>2</sub>	0 A <sub>1</sub> B <sub>1</sub>	1 A <sub>0</sub> B <sub>0</sub>	Set Row Address	A[6:0]: Start Address. [reset=0] B[6:0]: End Address. [reset=127] Range from 0 to 127
0	5C	0	1	0	1	1	1	0	0	Write RAM Command	Enable MCU to write Data into RAM
0	5D	0	1	0	1	1	1	0	1	Read RAM Command	Enable MCU to read Data from RAM
0 1 1	A0 A[7:0] B[7:0]	1 A <sub>7</sub> 0	0 A <sub>6</sub> 0	1 A <sub>5</sub> 0	0 A <sub>4</sub> 0	0 A <sub>3</sub> 0	0 A <sub>2</sub> 0	0 A <sub>1</sub> 0	0 A <sub>0</sub> 0	Set Re-map / Color Depth (Display RAM to Panel)	A[0]=0b, Horizontal address increment [reset] A[0]=1b, Vertical address increment  A[1]=0b, Column address 0 is mapped to SEG0 [reset] A[1]=1b, Column address 127 is mapped to SEG0  A[2]=0b, Color sequence: A → B → C [reset] A[2]=1b, Color sequence is swapped: C → B → A  A[3]=0b, Reserved [reset] A[3]=1b, Reserved  A[4]=0b, Scan from COM0 to COM[N-1] [reset] A[4]=1b, Scan from COM[N-1] to COM0. Where N is the Multiplex ratio.  A[5]=0b, Disable COM Split Odd Even A[5]=1b, Enable COM Split Odd Even [reset]  A[7:6] Set Color Depth, 00b: 256color 01b: 65k color [reset] 10b: 262k color 11b Pseudo 262k color, 16-bit format 2  Refer to Product Preview Table 6-6 for details



Fundamental Command Table											
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0 1	A1 A[6:0]	1 *	0 A <sub>6</sub>	1 A <sub>5</sub>	0 A <sub>4</sub>	0 A <sub>3</sub>	0 A <sub>2</sub>	0 A <sub>1</sub>	1 A <sub>0</sub>	Set Display Start Line	Set vertical scroll by RAM from 0~127. [reset=00h]
0 1	A2 A[6:0]	1 *	0 A <sub>6</sub>	1 A <sub>5</sub>	0 A <sub>4</sub>	0 A <sub>3</sub>	0 A <sub>2</sub>	1 A <sub>1</sub>	0 A <sub>0</sub>	Set Display Offset	Set vertical scroll by Row from 0-127. [reset=00h]
0	A4~A7	1	0	1	0	0	1	X <sub>1</sub>	X <sub>0</sub>	Set Display Mode	A4h: All OFF A5h: All ON (All pixels have GS63) A6h : Reset to normal display [reset] A7h: Inverse Display (GS0 -> GS63, GS1 -> GS62, ....)
0	AE~AF	1	0	1	0	1	1	1	X <sub>0</sub>	Set Sleep mode ON/OFF	A Eh = Sleep mode On (Display OFF) A Fh = Sleep mode OFF (Display ON)
0 1	B1 A[7:0]	1 A <sub>7</sub>	0 A <sub>6</sub>	1 A <sub>5</sub>	1 A <sub>4</sub>	0 A <sub>3</sub>	0 A <sub>2</sub>	0 A <sub>1</sub>	1 A <sub>0</sub>	Set Reset (Phase 1) / Pre-charge (Phase 2) period	A[3:0] Phase 1 period of 2~30 DCLK(s) clocks [reset=0100b] A[3:0]: 0 invalid 1 = 2 DCLKs 2 = 4 DCLKs : 15 = 30DCLKs  A[7:4] Phase 2 period of 2~30 DCLK(s) clocks [reset=1000b] A[7:4]: 0 invalid 1 = 2 DCLKs 2 = 4 DCLKs : 15 = 30DCLKs  Note (1) 0 DCLK is invalid in phase 1 & phase 2

Fundamental Command Table																																	
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																						
0 1	B3 A[7:0]	1 A <sub>7</sub>	0 A <sub>6</sub>	1 A <sub>5</sub>	1 A <sub>4</sub>	0 A <sub>3</sub>	0 A <sub>2</sub>	1 A <sub>1</sub>	1 A <sub>0</sub>	Front Clock Divider (DivSet)/ Oscillator Frequency	A[3:0] [reset=0000b], divide by DIVSET where <table border="1"><tr><td>A[3:0]</td><td>DIVSET</td></tr><tr><td>0000</td><td>divide by 1</td></tr><tr><td>0001</td><td>divide by 2</td></tr><tr><td>0010</td><td>divide by 4</td></tr><tr><td>0011</td><td>divide by 8</td></tr><tr><td>0100</td><td>divide by 16</td></tr><tr><td>0101</td><td>divide by 32</td></tr><tr><td>0110</td><td>divide by 64</td></tr><tr><td>0111</td><td>divide by 128</td></tr><tr><td>1000</td><td>divide by 256</td></tr><tr><td>&gt;=1001</td><td>invalid</td></tr></table> A[7:4] Oscillator frequency, frequency increases as level increases [reset=0010b]	A[3:0]	DIVSET	0000	divide by 1	0001	divide by 2	0010	divide by 4	0011	divide by 8	0100	divide by 16	0101	divide by 32	0110	divide by 64	0111	divide by 128	1000	divide by 256	>=1001	invalid
A[3:0]	DIVSET																																
0000	divide by 1																																
0001	divide by 2																																
0010	divide by 4																																
0011	divide by 8																																
0100	divide by 16																																
0101	divide by 32																																
0110	divide by 64																																
0111	divide by 128																																
1000	divide by 256																																
>=1001	invalid																																
0 1	B6 A[3:0]	1 0	0 0	1 0	1 0	0 A <sub>3</sub>	1 A <sub>2</sub>	0 A <sub>1</sub>	0 A <sub>0</sub>	Set Second Pre-charge Period	A[3:0] Set Second Pre-charge Period  0000b invalid 0001b 1 DCLKS 0010b 2 DCLKS  1000 8 DCLKS [reset]  1111 15 DCLKS																						
0 1 1 1 1 1 1 1	B8 A1[7:0] A2[7:0] . . . A62[7:0] A63[7:0]	1 A1 <sub>7</sub> A2 <sub>7</sub> . . . A62 <sub>7</sub> A63 <sub>7</sub>	0 A1 <sub>6</sub> A2 <sub>6</sub> . . . A62 <sub>6</sub> A63 <sub>6</sub>	1 A1 <sub>5</sub> A2 <sub>5</sub> . . . A62 <sub>5</sub> A63 <sub>5</sub>	1 A1 <sub>4</sub> A2 <sub>4</sub> . . . A62 <sub>4</sub> A63 <sub>4</sub>	1 A1 <sub>3</sub> A2 <sub>3</sub> . . . A62 <sub>3</sub> A63 <sub>3</sub>	0 A1 <sub>2</sub> A2 <sub>2</sub> . . . A62 <sub>2</sub> A63 <sub>2</sub>	0 A1 <sub>1</sub> A2 <sub>1</sub> . . . A62 <sub>1</sub> A63 <sub>1</sub>	0 A1 <sub>0</sub> A2 <sub>0</sub> . . . A62 <sub>0</sub> A63 <sub>0</sub>	Master Look Up Table for Gray Scale Pulse width (Color A,B,C)	The next 63 data bytes define Gray Scale (GS) Table by setting the gray scale pulse width in unit of DCLK's (ranges from 0d ~ 180d).  A1[7:0]: Gamma Setting for GS1, A2[7:0]: Gamma Setting for GS2, . A62[7:0]: Gamma Setting for GS62, A63[7:0]: Gamma Setting for GS63  <b>Note</b> ( <sup>1</sup> ) 0 ≤ Setting of GS1 < Setting of GS2 < Setting of GS3..... < Setting of GS62 < Setting of GS63 ( <sup>2</sup> ) GS0 does not has pre-charge and current drive stages. ( <sup>3</sup> ) GS1 can be set as only pre-charge but no current drive stage by input gamma setting for GS1 equals 0. ( <sup>4</sup> ) When command B8h is input only, color A, B, C will follow the master LUT. ( <sup>5</sup> ) When command BCh is input, it selects individual LUT for color A, GS1~31A; When command BDh is input, it selects individual LUT for color C, GS1~31C ( <sup>6</sup> ) To select individual LUT for color B, A and C, command B8h should be input before command BCh and BDh,																						

Fundamental Command Table																																
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																					
0	B9	1	0	1	1	1	0	0	1	Use Built-in Linear LUT [reset= linear]	Reset to default Look Up Table: <table><tr><th>Color A</th><th>Color B</th><th>Color C</th></tr><tr><td>GS1A = 0 DCLK</td><td>GS1B = 0 DCLK</td><td>GS1C = 0 DCLK</td></tr><tr><td>GS2A = 4 DCLK</td><td>GS2B = 2 DCLK</td><td>GS2C = 4 DCLK</td></tr><tr><td>GS3A = 8 DCLK</td><td>GS3B = 4 DCLK</td><td>GS3C = 8 DCLK</td></tr><tr><td>...</td><td>...</td><td>...</td></tr><tr><td>GS31A = 120 DCLK</td><td>GS62B = 122 DCLK</td><td>GS31C = 120 DCLK</td></tr><tr><td></td><td>GS63B = 124 DCLK</td><td></td></tr></table>	Color A	Color B	Color C	GS1A = 0 DCLK	GS1B = 0 DCLK	GS1C = 0 DCLK	GS2A = 4 DCLK	GS2B = 2 DCLK	GS2C = 4 DCLK	GS3A = 8 DCLK	GS3B = 4 DCLK	GS3C = 8 DCLK	...	...	...	GS31A = 120 DCLK	GS62B = 122 DCLK	GS31C = 120 DCLK		GS63B = 124 DCLK	
Color A	Color B	Color C																														
GS1A = 0 DCLK	GS1B = 0 DCLK	GS1C = 0 DCLK																														
GS2A = 4 DCLK	GS2B = 2 DCLK	GS2C = 4 DCLK																														
GS3A = 8 DCLK	GS3B = 4 DCLK	GS3C = 8 DCLK																														
...	...	...																														
GS31A = 120 DCLK	GS62B = 122 DCLK	GS31C = 120 DCLK																														
	GS63B = 124 DCLK																															
0	BB	1	0	1	1	1	0	1	1	Set Pre-charge voltage	Set pre-charge voltage level.[reset = 11110b] <table><tr><th>A[4:0]</th><th>Hex code</th><th>pre-charge voltage</th></tr><tr><td>00000</td><td>00h</td><td>0.10 x V<sub>CC</sub></td></tr><tr><td>:</td><td>:</td><td>:</td></tr><tr><td>11110</td><td>1Eh</td><td>0.50 x V<sub>CC</sub> [reset]</td></tr><tr><td>11111</td><td>1Fh</td><td>0.5133 x V<sub>CC</sub></td></tr></table> <b>Note</b> (1)Pre-charge voltage level must be smaller than COM deselect voltage level	A[4:0]	Hex code	pre-charge voltage	00000	00h	0.10 x V <sub>CC</sub>	:	:	:	11110	1Eh	0.50 x V <sub>CC</sub> [reset]	11111	1Fh	0.5133 x V <sub>CC</sub>						
A[4:0]	Hex code	pre-charge voltage																														
00000	00h	0.10 x V <sub>CC</sub>																														
:	:	:																														
11110	1Eh	0.50 x V <sub>CC</sub> [reset]																														
11111	1Fh	0.5133 x V <sub>CC</sub>																														
1	A[4:0]	0	0	0	A <sub>4</sub>	A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>																							
0	BC	1	0	1	1	1	1	0	0	Individual Look Up Table for Gray Scale Pulse width (Color A)	The next 31 data bytes define Gray Scale (GS) Table by setting the gray scale pulse width in unit of DCLK's (ranges from 0d ~ 180d) for color A.  A1[7:0]: Gamma Setting for GS1A, A2[7:0]: Gamma Setting for GS2A, : A62[7:0]: Gamma Setting for GS30A, A63[7:0]: Gamma Setting for GS31A  <b>Note</b> (1) 0 ≤ Setting of GS1 < Setting of GS2 < Setting of GS3..... < Setting of GS30 < Setting of GS31 (2) GS0 does not has pre-charge and current drive stages. (3) GS1 can be set as only pre-charge but no current drive stage by input gamma setting for GS1 equals 0. (4) When command B8h is input, it selects one LUT for color A, B and C. i.e. GS1~31A, GS1~63B and GS1~31C are updated. (5) Command B8h should be input before command BCh and BDh to select individual LUT for color B, A and C.																					
1	A1[7:0]	A1 <sub>7</sub>	A1 <sub>6</sub>	A1 <sub>5</sub>	A1 <sub>4</sub>	A1 <sub>3</sub>	A1 <sub>2</sub>	A1 <sub>1</sub>	A1 <sub>0</sub>																							
1	A2[7:0]	A2 <sub>7</sub>	A2 <sub>6</sub>	A2 <sub>5</sub>	A2 <sub>4</sub>	A2 <sub>3</sub>	A2 <sub>2</sub>	A2 <sub>1</sub>	A2 <sub>0</sub>																							
1	.	.	.	.	.	.	.	.	.																							
1	.	.	.	.	.	.	.	.	.																							
1	.	.	.	.	.	.	.	.	.																							
1	A30[7:0]	A30 <sub>7</sub>	A30 <sub>6</sub>	A30 <sub>5</sub>	A30 <sub>4</sub>	A30 <sub>3</sub>	A30 <sub>2</sub>	A30 <sub>1</sub>	A30 <sub>0</sub>																							
1	A31[7:0]	A31 <sub>7</sub>	A31 <sub>6</sub>	A31 <sub>5</sub>	A31 <sub>4</sub>	A31 <sub>3</sub>	A31 <sub>2</sub>	A31 <sub>1</sub>	A31 <sub>0</sub>																							

**Fundamental Command Table**

D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																		
0	BD	1	0	1	1	1	1	0	1	Individual Look Up Table for Gray Scale Pulse width (Color C)	The next 31 data bytes define Gray Scale (GS) Table by setting the gray scale pulse width in unit of DCLK's (ranges from 0d ~ 180d) for color C.																		
1	A1[7:0]	A1 <sub>7</sub>	A1 <sub>6</sub>	A1 <sub>5</sub>	A1 <sub>4</sub>	A1 <sub>3</sub>	A1 <sub>2</sub>	A1 <sub>1</sub>	A1 <sub>0</sub>		A1[7:0]: Gamma Setting for GS1C,																		
1	A2[7:0]	A2 <sub>7</sub>	A2 <sub>6</sub>	A2 <sub>5</sub>	A2 <sub>4</sub>	A2 <sub>3</sub>	A2 <sub>2</sub>	A2 <sub>1</sub>	A2 <sub>0</sub>		A2[7:0]: Gamma Setting for GS2C,																		
1	.	.	.	.	.	.	.	.	.		⋮																		
1	.	.	.	.	.	.	.	.	.		A62[7:0]: Gamma Setting for GS30C,																		
1	.	.	.	.	.	.	.	.	.		A63[7:0]: Gamma Setting for GS31C																		
1	A30[7:0]	A30 <sub>7</sub>	A30 <sub>6</sub>	A30 <sub>5</sub>	A30 <sub>4</sub>	A30 <sub>3</sub>	A30 <sub>2</sub>	A30 <sub>1</sub>	A30 <sub>0</sub>																				
1	A31[7:0]	A31 <sub>7</sub>	A31 <sub>6</sub>	A31 <sub>5</sub>	A31 <sub>4</sub>	A31 <sub>3</sub>	A31 <sub>2</sub>	A31 <sub>1</sub>	A31 <sub>0</sub>																				
0	BE	1	0	1	1	1	1	1	0	Set V <sub>COMH</sub> Voltage	Set COM deselect voltage level [reset = 05h]																		
1	A[2:0]	0	0	0	0	0	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>		<table><tr><th>A[2:0]</th><th>Hex code</th><th>V<sub>COMH</sub></th></tr><tr><td>000</td><td>00h</td><td>0.72 x V<sub>CC</sub></td></tr><tr><td>:</td><td>:</td><td>:</td></tr><tr><td>101</td><td>05h</td><td>0.82 x V<sub>CC</sub> [reset]</td></tr><tr><td>:</td><td>:</td><td>:</td></tr><tr><td>111</td><td>07h</td><td>0.86 x V<sub>CC</sub></td></tr></table>	A[2:0]	Hex code	V <sub>COMH</sub>	000	00h	0.72 x V <sub>CC</sub>	:	:	:	101	05h	0.82 x V <sub>CC</sub> [reset]	:	:	:	111	07h	0.86 x V <sub>CC</sub>
A[2:0]	Hex code	V <sub>COMH</sub>																											
000	00h	0.72 x V <sub>CC</sub>																											
:	:	:																											
101	05h	0.82 x V <sub>CC</sub> [reset]																											
:	:	:																											
111	07h	0.86 x V <sub>CC</sub>																											
0	C1	1	1	0	0	0	0	0	1	Set Contrast Current for Color A,B,C	A[7:0] Contrast Value Color A [reset=7Fh]																		
1	A[7:0]	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	A <sub>4</sub>	A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>		B[7:0] Contrast Value Color B [reset=7Fh]																		
1	B[7:0]	B <sub>7</sub>	B <sub>6</sub>	B <sub>5</sub>	B <sub>4</sub>	B <sub>3</sub>	B <sub>2</sub>	B <sub>1</sub>	B <sub>0</sub>		C[7:0] Contrast Value Color C [reset=7Fh]																		
1	C[7:0]	C <sub>7</sub>	C <sub>6</sub>	C <sub>5</sub>	C <sub>4</sub>	C <sub>3</sub>	C <sub>2</sub>	C <sub>1</sub>	C <sub>0</sub>																				
0	C7	1	1	0	0	0	1	1	1	Master Contrast Current Control	A[3:0] :																		
1	A[3:0]	*	*	*	*	A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>		0000b reduce output currents for all colors to 1/16																		
											0001b reduce output currents for all colors to 2/16																		
											⋮																		
											1110b reduce output currents for all colors to 15/16																		
											1111b no change [reset]																		
0	CA	1	1	0	0	1	0	1	0	Set MUX Ratio	A[6:0] MUX ratio 4MUX ~ 128MUX, [reset=127], (Range from 3 to 127)																		
1	A[6:0]	0	A <sub>6</sub>	A <sub>5</sub>	A <sub>4</sub>	A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>																				
0	E3	1	1	1	0	0	0	1	1	NOP	Command for No Operation																		

Fundamental Command Table											
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	FD	1	1	1	1	1	1	0	1	Set Command Lock	A[7:0]: MCU protection status [reset = 12h]
1	A[7:0]	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	A <sub>4</sub>	A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>		A[7:0] = 12h, Unlock OLED driver IC MCU interface from entering command [reset]
											A[7:0] = 16h, Lock OLED driver IC MCU interface from entering command
											<b>Note</b> (1) The locked OLED driver IC MCU interface prohibits all commands and memory access except the FDh command.

# Note

<sup>(1)</sup> “\*” stands for “Don’t care”.



## Graphic Acceleration Command List

Set (GAC) (D/C# = 0, R/W#(WR#)= 0, E(RD#) = 1) unless specific setting is stated

Single byte command (D/C# = 0), Multiple byte command (D/C# = 0 for first byte, D/C# = 1 for other bytes)

Graphic acceleration command										
D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Description
0	96	1	0	0	1	0	1	1	0	Horizontal Scroll
1	A[7:0]	A <sub>7</sub>	A <sub>6</sub>	A <sub>5</sub>	A <sub>4</sub>	A <sub>3</sub>	A <sub>2</sub>	A <sub>1</sub>	A <sub>0</sub>	
1	B[6:0]	0	B <sub>6</sub>	B <sub>5</sub>	B <sub>4</sub>	B <sub>3</sub>	B <sub>2</sub>	B <sub>1</sub>	B <sub>0</sub>	
1	C[7:0]	0	C <sub>6</sub>	C <sub>5</sub>	C <sub>4</sub>	C <sub>3</sub>	C <sub>2</sub>	C <sub>1</sub>	C <sub>0</sub>	
1	D[6:0]	0	D <sub>6</sub>	D <sub>5</sub>	D <sub>4</sub>	D <sub>3</sub>	D <sub>2</sub>	D <sub>1</sub>	D <sub>0</sub>	
1	E[1:0]	0	0	0	0	0	0	E <sub>1</sub>	E <sub>0</sub>	
										A[7:0] = 00000000b No scrolling A[7:0] = 00000001b to 00111111b Scroll towards SEG127 with 1 column offset A[7:0] = 01000000b to 11111111b Scroll towards SEG0 with 1 column offset  B[6:0] : start row address  C[7:0] : end row address  D[6:0] : Reserved (reset=00h)  E[1:0] : scrolling time interval 00b Invalid 01b normal 10b slow 11b slowest  <b>Note</b> Operates during display ON.
0	9E	1	0	0	1	1	1	1	0	Stop horizontal scroll  Stop Moving  <b>Note</b> After sending 9Eh command to stop the scrolling action, the ram data needs to be rewritten
0	9F	1	0	0	1	1	1	1	1	Start horizontal scroll

### Note

(2) "\*" stands for "Don't care".

## 6.5 TOUCH PANEL's application code.

### 6.5.1 I2C address format

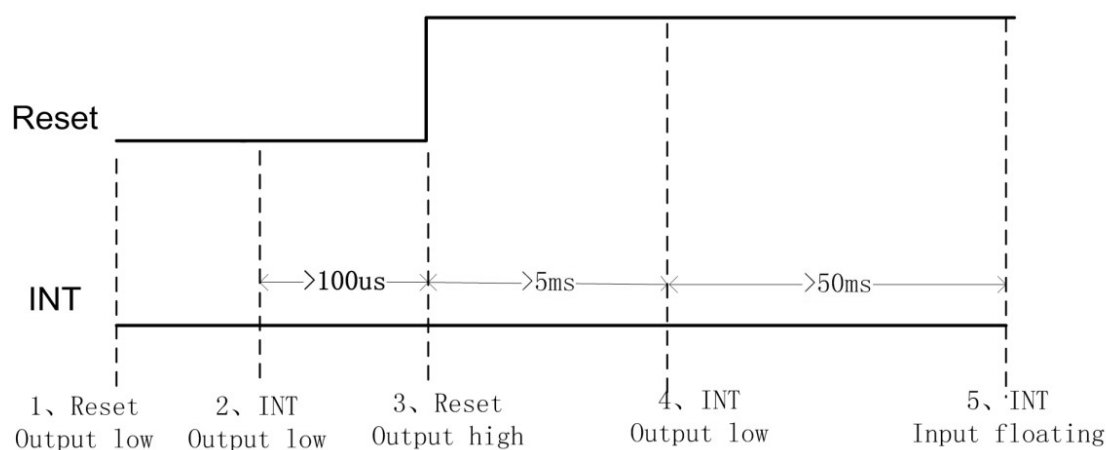
GT911 supports two I2C slave addresses: 0xBA/0xBB and 0x28/0x29.

Item	Write	Read
	Address_W	Address_R
0xBA/0xBB address	0xBA	0xBB
0x28/0x29 address	0x28	0x29

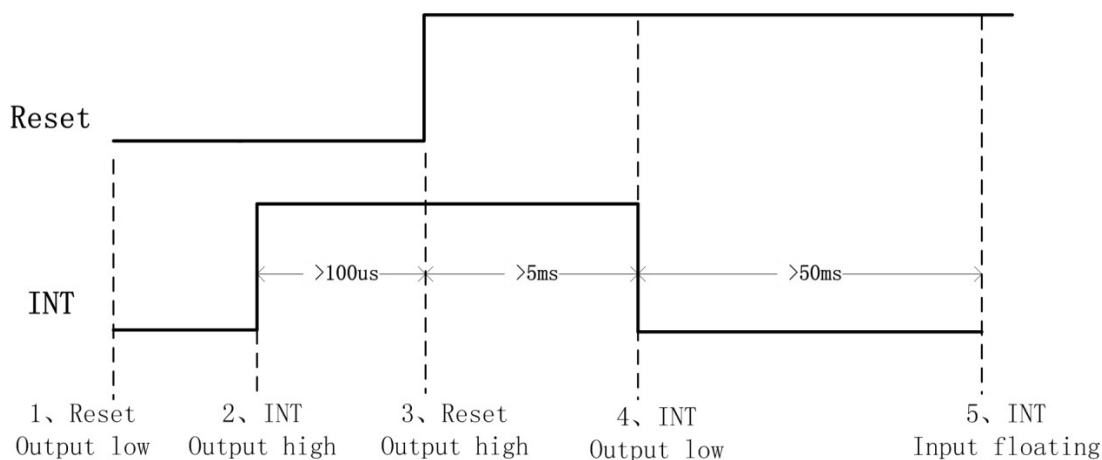
### 6.5.2 Power on for I2C address select

The host can select the address by changing the status of Reset and INT pins during the power-on initialization phase. See the diagram below for configuration methods and timings:

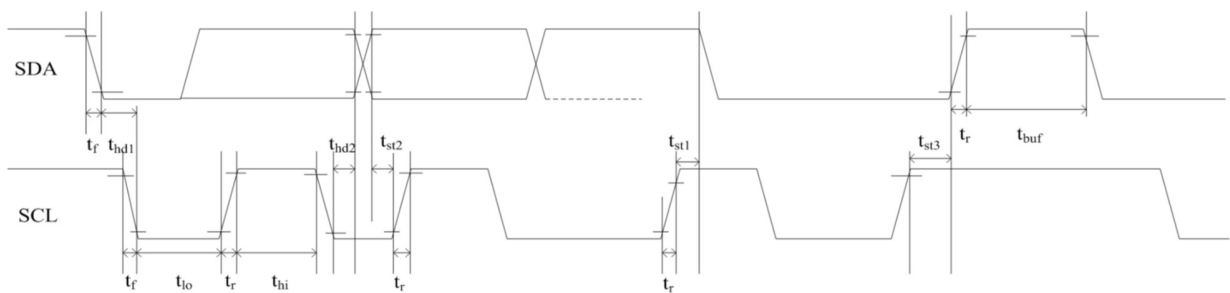
#### Timing for initial setting slave address to 0xBA/0xBB:



#### Timing for initial setting slave address to 0x28/0x29:



### 6.5.3 I2C Timing



### 3.3V communication interface, 400Kbps, pull up resistor is 2K ohm

Parameter	Symbol	Min.	Max.	Unit
SCL low period	$t_{lo}$	1.3	-	us
SCL high period	$t_{hi}$	0.6	-	us
SCL setup time for Start condition	$t_{st1}$	0.6	-	us
SCL setup time for Stop condition	$t_{st3}$	0.6	-	us
SCL hold time for Start condition	$t_{hd1}$	0.6	-	us
SDA setup time	$t_{st2}$	0.1	-	us
SDA hold time	$t_{hd2}$	0	-	us

### 6.5.4 Data Transmission

(ex: slave address is 0xBA/0xBB)

Communication is always initiated by master, A high-to-low transition of SDA with SCL high is a All addressing signal are serially transmitted to and from on bus in 8-bit word. GT911 sends a “0” to acknowledge when the addressing word is 0xBA/BB (or 0x28/0x29 ).

This happens during the ninth clock cycle. If the slave address is not matched, GT911 will stay in idle state.

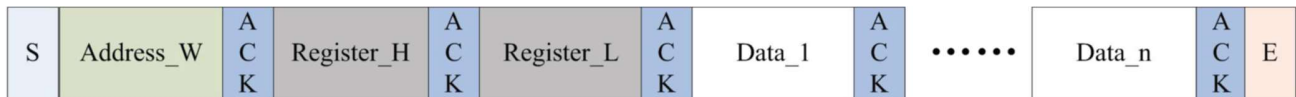
The data words are serially transmitted to and from in 9-bit formation: 8-bit data + 1-bit ACK or NACK sent by GT911. Data changes during SCL low periods & keeps valid during SCL high.

A low-to-high transition of SDA with SCL high is a stop condition.



### 6.5.5 Write Data to GT911

(ex: slave address is 0xBA/0xBB)



#### Write operations

Please check the above figure, master start the communication first, and then sends device address 0XBA preparing for a write operation.

After receiving ACK from GT911, master sends out 16-bit register address, and then the data word in 8-bit, which is going to be wrote into GT911.

The address pointer of GT911 will automatically increase one after one byte writing, so master can sequentially write in one operation. When operation finished, master stop the communication.

### 6.5.6 Read Data from GT911

(ex: slave address is 0xBA/0xBB)



#### Read operations

The diagram above is the timing sequence of the host reading data from GT911. First, the host issues a Start condition and sends 0XBA (address bits and R/W bit; R/W bit as 0 indicates Write operation) to the slave device.

After receiving ACK, the host sends the 16-bit register address (where reading starts) to the slave device. Then the host sets register addresses which need to be read.

Also after receiving ACK, the host issues the Start condition once again and sends 0XBB (Read Operation). After receiving ACK, the host starts to read data.

GT911 also supports continuous Read Operation and, by default, reads data continuously. Whenever receiving a byte of data, the host sends an ACK signal indicating successful reception. After receiving the last byte of data, the host sends a NACK signal followed by a STOP condition which terminates communication.

### 6.5.7 Coordinates Information

Addr	Access	bit7	bit6	bit5	bit4	bit3	bit2	bit1	bit0
0x814E	R/W	buffer status	large detect	Reserved		number of touch points			
0x814F	R	track id							
0x8150	R	point 1 x coordinate (low byte)							
0x8151	R	point 1 x coordinate (high byte)							
0x8152	R	point 1 y coordinate (low byte)							
0x8153	R	point 1 y coordinate (high byte)							
0x8154	R	Point 1 size (low byte)							
0x8155	R	point 1 size (high byte)							
0x8156	R	Reserved							

\* Addr = [Register\_H : Register\_L]

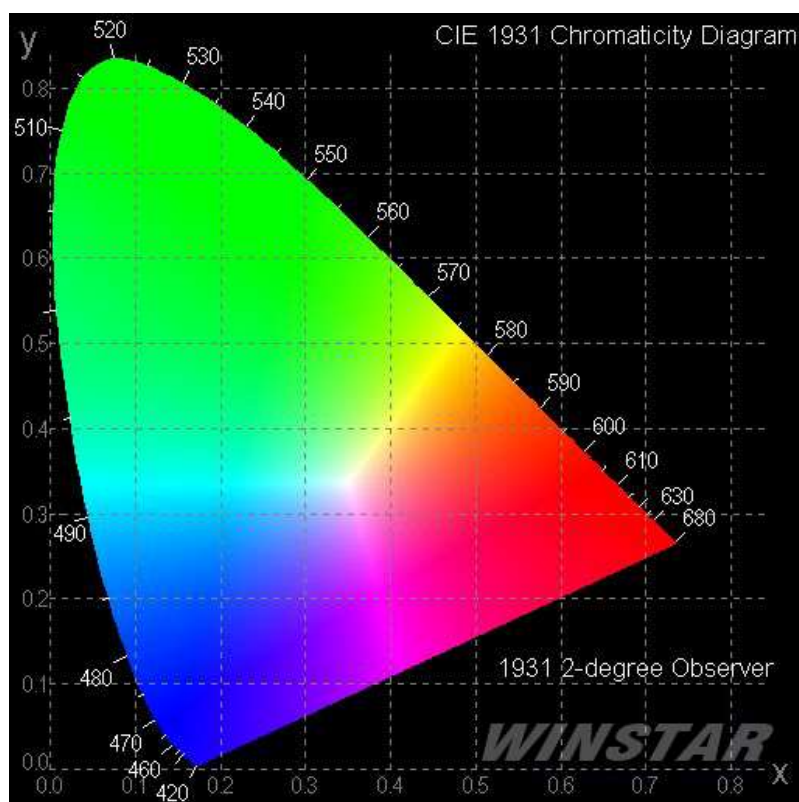
Buffer status, 1 = coordinate (or key) is ready for host to read; 0 = coordinate (or key) is not ready and data is not valid. After reading coordinates, host should configure this flag (or the entire byte) to 0 via I2C.

Large detect, 1 indicates there is large-area touch on TP.

Note: X-Y Resolutions:256 x 128

## 7.Optical Characteristics

Item	Symbol	Condition	Min	Typ	Max	Unit
View Angle	(V) $\theta$	—	160	—	—	deg
	(H) $\phi$	—	160	—	—	deg
Contrast Ratio	CR	Dark	10,000:1	—	—	—
Response Time	T rise	—	—	10	—	$\mu$ s
	T fall	—	—	10	—	$\mu$ s
Display with 50% check Board Brightness			60	80	—	cd/m <sup>2</sup>
CIEx(White)		(CIE1931)	0.26	0.28	0.30	—
CIEx(White)		(CIE1931)	0.30	0.32	0.34	—



## 8.OLED Lifetime

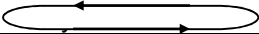
ITEM	Conditions	Min	Typ	Remark
Operating Life Time	Ta=25°C / Initial 50% checkerboard brightness Typical Value	20,000 Hrs	—	Note

Notes:

1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
3. Screen saving mode will extend OLED lifetime.

# 9. Reliability

## Content of Reliability Test

Environmental Test			
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 240hrs	—
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 240hrs	—
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 240hrs	—
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 240hrs	—
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60°C, 90%RH 240hrs	—
High Temperature/ Humidity Operation	Endurance test applying the high temperature and high humidity Operation for a long time.	60°C, 90%RH 120hrs	—
Temperature Cycle	Endurance test applying the low and high temperature cycle. <div style="display: flex; justify-content: space-around; align-items: center;"> <span>-30°C    25°C    80°C</span> </div> <div style="display: flex; justify-content: space-around; align-items: center; margin-top: 10px;"> <span>30min    5min    30min</span>  </div>	-30°C / 80°C 30 cycles	—
Mechanical Test			
Vibration test	Endurance test applying the vibration during transportation and using.	Frequency: 10~55Hz amplitude: 1.5mm Time: 0.5hrs/axis Test axis: X, Y, Z	—
Others			
Static electricity test	Endurance test applying the electric stress to the finished product housing.	Air Discharge model ±4kv, 10 times	—

\*\*\* Supply voltage for OLED system = Operating voltage at 25°C

**Test and measurement conditions**

1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at  $23\pm5^{\circ}\text{C}$ ;  $55\pm15\%$  RH.
2. All-pixels on/off exchange is used as operation test pattern.
3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/Humidity Storage, Temperature Cycle

**Evaluation criteria**

1. The function test is OK.
2. No observable defects.
3. Luminance:  $> 50\%$  of initial value.
4. Current consumption: within  $\pm 50\%$  of initial value.

**APPENDIX:****RESIDUE IMAGE**

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.

# 10. Inspection specification

## Inspection Standard:

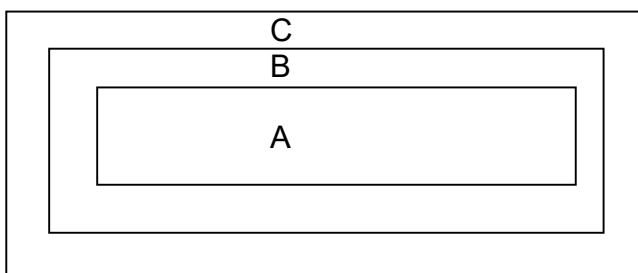
MIL-STD-105E table normal inspection single sample level II.

## Definition

1 Major defect : The defect that greatly affect the usability of product.

2 Minor defect : The other defects, such as cosmetic defects, etc.

Definition of inspection zone:



Zone A: Active Area

Zone B: Viewing Area except Zone A

Zone C: Outside Viewing Area

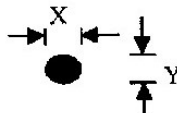
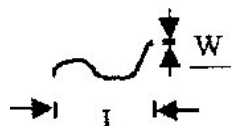
Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble of quality and assembly to customer's product.

## Inspection Methods

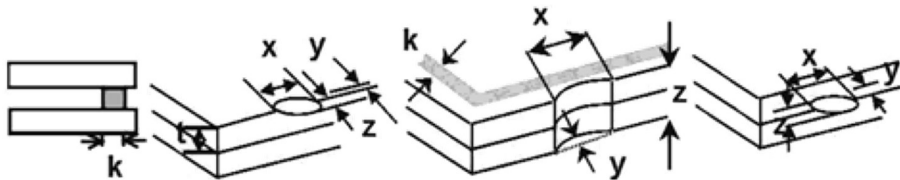
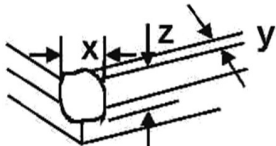
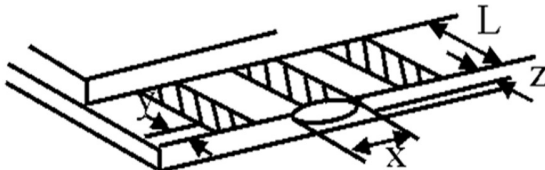
1 The general inspection : Under fluorescent light illumination: 750~1500 Lux, about 30cm viewing distance, within 45° viewing angle, under 25±5°C.

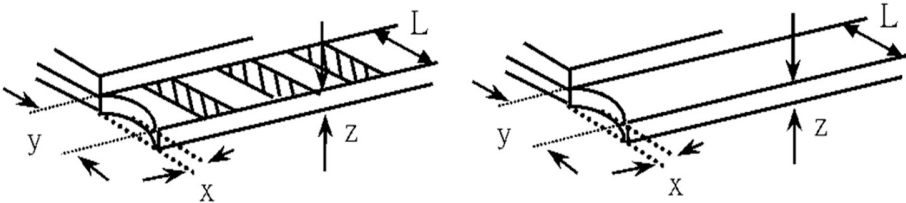
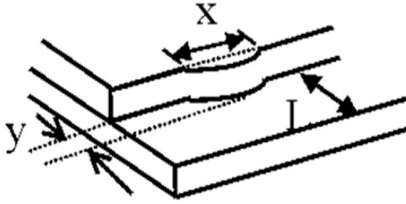
2 The luminance and color coordinate inspection : By SR-3 or BM-7 or the equal equipments, in the dark room, under 25±5°C.

NO	Item	Criterion	AQL
01	Electrical Testing	1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character , dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect.	0.65
02	Black or white spots on OLED (display only)	2.1 White and black spots on display 0.25mm, no more than three white or black spots present. 2.2 Densely spaced: No more than two spots or lines within 3mm.	2.5

NO	Item	Criterion	AQL																			
03	OLED black spots, white spots, contamination (non-display)	<div> <div>3.1 Round type :</div> <div>As following drawing</div> <div> <math>\Phi=(x+y)/2</math>  </div> <table> <tr> <th>SIZE</th> <th>Acceptable QTY</th> <th>Zone</th> </tr> <tr> <td><math>\Phi \leq 0.10</math></td> <td>ignore</td> <td>A+ B</td> </tr> <tr> <td><math>0.10 &lt; \Phi \leq 0.20</math></td> <td>2</td> <td>A+ B</td> </tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.25</math></td> <td>1</td> <td>A+ B</td> </tr> <tr> <td><math>0.25 &lt; \Phi</math></td> <td>0</td> <td>A+ B</td> </tr> </table> </div>	SIZE	Acceptable QTY	Zone	$\Phi \leq 0.10$	ignore	A+ B	$0.10 < \Phi \leq 0.20$	2	A+ B	$0.20 < \Phi \leq 0.25$	1	A+ B	$0.25 < \Phi$	0	A+ B	2.5				
	SIZE	Acceptable QTY	Zone																			
$\Phi \leq 0.10$	ignore	A+ B																				
$0.10 < \Phi \leq 0.20$	2	A+ B																				
$0.20 < \Phi \leq 0.25$	1	A+ B																				
$0.25 < \Phi$	0	A+ B																				
		<div> <div>3.2 Line type : (As following drawing)</div> <div>  <table> <tr> <th>Length</th> <th>Width</th> <th>Acceptable QTY</th> <th>Zone</th> </tr> <tr> <td>---</td> <td><math>W \leq 0.02</math></td> <td>ignore</td> <td>A+B</td> </tr> <tr> <td><math>L \leq 3.0</math></td> <td><math>0.02 &lt; W \leq 0.03</math></td> <td rowspan="2">2</td> <td>A+B</td> </tr> <tr> <td><math>L \leq 2.5</math></td> <td><math>0.03 &lt; W \leq 0.05</math></td> <td>A+B</td> </tr> <tr> <td>---</td> <td><math>0.05 &lt; W</math></td> <td>As round type</td> <td></td> </tr> </table> </div> </div>	Length	Width	Acceptable QTY	Zone	---	$W \leq 0.02$	ignore	A+B	$L \leq 3.0$	$0.02 < W \leq 0.03$	2	A+B	$L \leq 2.5$	$0.03 < W \leq 0.05$	A+B	---	$0.05 < W$	As round type		2.5
Length	Width	Acceptable QTY	Zone																			
---	$W \leq 0.02$	ignore	A+B																			
$L \leq 3.0$	$0.02 < W \leq 0.03$	2	A+B																			
$L \leq 2.5$	$0.03 < W \leq 0.05$		A+B																			
---	$0.05 < W$	As round type																				
04	Polarizer bubbles /Dent	<div> <div>4.1 If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.</div> <table> <tr> <th>Size <math>\Phi</math></th> <th>Acceptable QTY</th> <th>Zone</th> </tr> <tr> <td><math>\Phi \leq 0.20</math></td> <td>ignore</td> <td>A+B</td> </tr> <tr> <td><math>0.20 &lt; \Phi \leq 0.50</math></td> <td>3</td> <td>A+B</td> </tr> <tr> <td><math>0.50 &lt; \Phi \leq 1.00</math></td> <td>2</td> <td>A+B</td> </tr> <tr> <td><math>1.00 &lt; \Phi</math></td> <td>0</td> <td>A+B</td> </tr> <tr> <td>Total QTY</td> <td>3</td> <td></td> </tr> </table> <div>4.2 The polarizer dent follows this specification.</div> </div>	Size $\Phi$	Acceptable QTY	Zone	$\Phi \leq 0.20$	ignore	A+B	$0.20 < \Phi \leq 0.50$	3	A+B	$0.50 < \Phi \leq 1.00$	2	A+B	$1.00 < \Phi$	0	A+B	Total QTY	3		2.5	
Size $\Phi$	Acceptable QTY	Zone																				
$\Phi \leq 0.20$	ignore	A+B																				
$0.20 < \Phi \leq 0.50$	3	A+B																				
$0.50 < \Phi \leq 1.00$	2	A+B																				
$1.00 < \Phi$	0	A+B																				
Total QTY	3																					
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination.																				

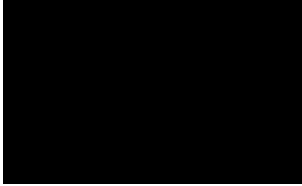
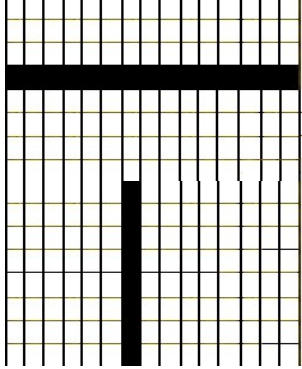
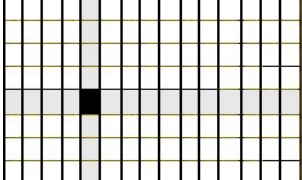
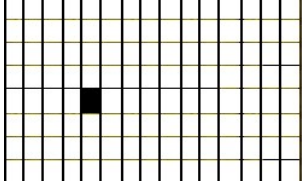
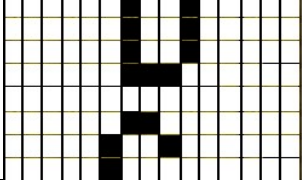
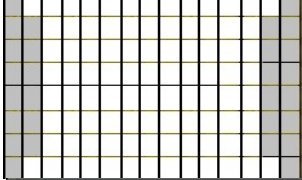
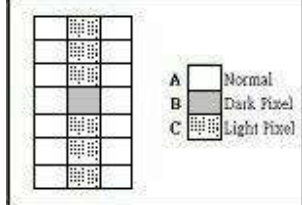


NO	Item	Criterion	AQL																		
06	Chipped glass	<p>Symbols Define: x: Chip length      y: Chip width      z: Chip thickness k: Seal width      t: Glass thickness      a: OLED side length L: Electrode pad length: 6.1 General glass chip : 6.1.1 Chip on panel surface and crack between panels:</p>  <table><tr><td>z: Chip thickness</td><td>y: Chip width</td><td>x: Chip length</td></tr><tr><td><math>Z \leq 1/2t</math></td><td>Not over viewing area</td><td><math>x \leq 1/8a</math></td></tr><tr><td><math>1/2t &lt; z \leq 2t</math></td><td>Not exceed <math>1/3k</math></td><td><math>x \leq 1/8a</math></td></tr></table> <p>⊙ If there are 2 or more chips, x is total length of each chip.</p> <p>6.1.2 Corner crack:</p>  <table><tr><td>z: Chip thickness</td><td>y: Chip width</td><td>x: Chip length</td></tr><tr><td><math>Z \leq 1/2t</math></td><td>Not over viewing area</td><td><math>x \leq 1/8a</math></td></tr><tr><td><math>1/2t &lt; z \leq 2t</math></td><td>Not exceed <math>1/3k</math></td><td><math>x \leq 1/8a</math></td></tr></table> <p>⊙ If there are 2 or more chips, x is the total length of each chip.</p>	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed $1/3k$	$x \leq 1/8a$	z: Chip thickness	y: Chip width	x: Chip length	$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$	$1/2t < z \leq 2t$	Not exceed $1/3k$	$x \leq 1/8a$	2.5
z: Chip thickness	y: Chip width	x: Chip length																			
$Z \leq 1/2t$	Not over viewing area	$x \leq 1/8a$																			
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z: Chip thickness	y: Chip width	x: Chip length																			
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$1/2t < z \leq 2t$	Not exceed $1/3k$	$x \leq 1/8a$																			
06	Glass crack	<p>Symbols : x: Chip length      y: Chip width      z: Chip thickness k: Seal width      t: Glass thickness      a: OLED side length L: Electrode pad length 6.2 Protrusion over terminal : 6.2.1 Chip on electrode pad :</p>  <table><tr><td>y: Chip width</td><td>x: Chip length</td><td>z: Chip thickness</td></tr><tr><td><math>y \leq 0.5\text{mm}</math></td><td><math>x \leq 1/8a</math></td><td><math>0 &lt; z \leq t</math></td></tr></table>	y: Chip width	x: Chip length	z: Chip thickness	$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$	2.5												
y: Chip width	x: Chip length	z: Chip thickness																			
$y \leq 0.5\text{mm}$	$x \leq 1/8a$	$0 < z \leq t$																			

NO	Item	Criterion	AQL										
06	Glass crack	<div>6.2.2 Non-conductive portion:</div> <div></div> <table><tr><td>y: Chip width</td><td>x: Chip length</td><td>z: Chip thickness</td></tr><tr><td><math>y \leq L</math></td><td><math>x \leq 1/8a</math></td><td><math>0 &lt; z \leq t</math></td></tr></table> <div><div>○ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</div><div>○ If the product will be heat sealed by the customer, the alignment mark not be damaged.</div></div> <div>6.2.3 Substrate protuberance and internal crack.</div> <table><tr><td>y: width</td><td>x: length</td></tr><tr><td><math>y \leq 1/3L</math></td><td><math>x \leq a</math></td></tr></table> <div></div>	y: Chip width	x: Chip length	z: Chip thickness	$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$	y: width	x: length	$y \leq 1/3L$	$x \leq a$	2.5
y: Chip width	x: Chip length	z: Chip thickness											
$y \leq L$	$x \leq 1/8a$	$0 < z \leq t$											
y: width	x: length												
$y \leq 1/3L$	$x \leq a$												
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5										
08	Backlight elements	8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong.	0.65 2.5 0.65										
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.	2.5 0.65										
10	PCB , COB	10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5 2.5 0.65 2.5 2.5 0.65 0.65 2.5										



NO	Item	Criterion	AQL
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65
12	General appearance	12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet.	2.5 0.65 2.5 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65

Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	 

# 11. Precautions in use of OLED Modules

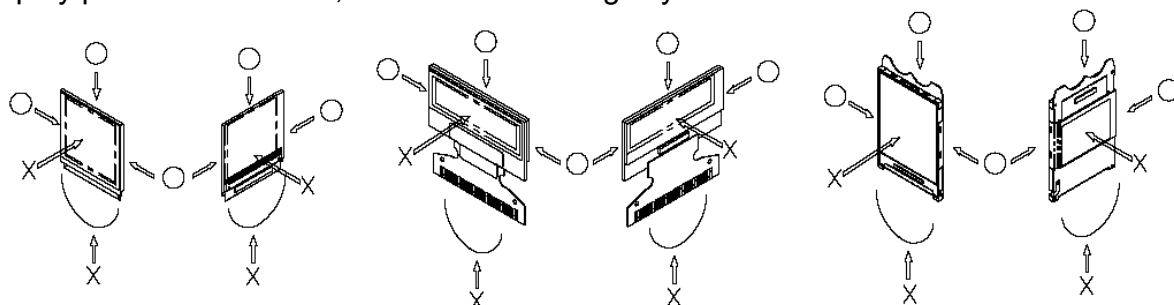
## Modules

- (1) Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, change the components or modify its shape of OLED display module.
- (3) Don't disassemble the OLED display module.
- (4) Do not apply input signals while the logic power is off.
- (5) Don't operate it above the absolute maximum rating.
- (6) Don't drop, bend or twist OLED display module.
- (7) Soldering: only to the I/O terminals.
- (8) Hot-Bar FPC soldering condition: 280~350C, less than 5 seconds.
- (9) Winstar has the right to change the passive components (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.) and change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) Winstar has the right to upgrade or modify the product function.
- (11) For COG & COF structure OLED products, customers should reserve VCC (VPP) adjustment function or software update function when designing OLED supporting circuit. (The progress of OLED light-emitting materials will increase the conversion efficiency and the brightness. The brightness can be adjusted if necessary).

### 11.1. Handling Precautions

- (1) Since the display panel is being made of glass, do not apply mechanical impacts such as dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale nor lick the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged. So, be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage by using following adhesion tape.
  - \* Scotch Mending Tape No. 810 or an equivalentNever try to breathe upon the soiled surface nor wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy. Also, pay attention that the following liquid and solvent may spoil the polarizer:
  - \* Water
  - \* Ketone
  - \* Aromatic Solvents
- (6) Protection film is being applied to the surface of the display panel and removes the protection film before assembling it. At this time, if the OLED display module has been stored for a long period of time, residue adhesive material of the protection film may remain on the surface of the display panel after removed of the film. In such case, remove the residue material by the method introduced in the above Section 5.
- (7) Do not touch the following sections whenever possible while handling the OLED display modules.
  - \* Pins and electrodes
  - \* Pattern layouts such as the TCP & FPC

- (8) Hold OLED display module very carefully when placing OLED display module into the System housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts. These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



- (9) Do not apply stress to the LSI chips and the surrounding molded sections.
- (10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.
- \* Be sure to make human body grounding when handling OLED display modules.
  - \* Be sure to ground tools to use or assembly such as soldering irons.
  - \* To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
  - \* Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when exfoliating the protective film.

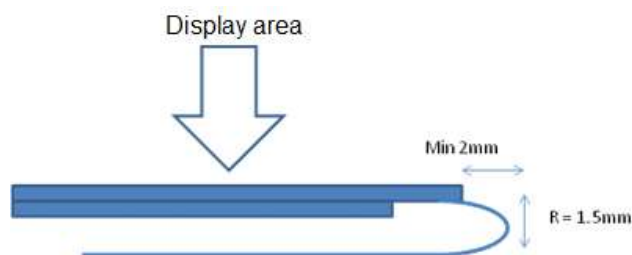
## 11.2. Storage Precautions

- (1) When storing OLED display modules, put them in static electricity preventive bags to avoid be directly exposed to sun or lights of fluorescent lamps. And, also, place in the temperature  $25\pm5^{\circ}\text{C}$  and Humidity below 65% RH.(We recommend you to store these modules in the packaged state when they were shipped from Winstar. At that time, be careful not to let water drops adhere to the packages or bags.)
- (2) When the OLED display module is being dewed or when it is placed under high temperature or high humidity environments, the electrodes may be corroded if electric current is applied. Please store it in clean environment.

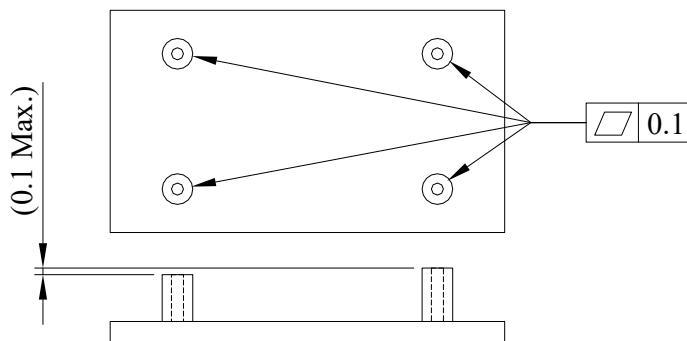
## 11.3. Designing Precautions

- (1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, OLED display module may be damaged.
- (2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specification and to make the signal line cable as short as possible.
- (3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD / VCC). (Recommend value: 0.5A)
- (4) Pay sufficient attention to avoid occurrence of mutual noise interference with the nearby devices.
- (5) As for EMI, take necessary measures on the equipment side basically.
- (6) If the power supplied to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.
- \* Connection (contact) to any other potential than the above may lead to rupture of the IC.
- (7) If this OLED driver is exposed to light, malfunctioning may occur and semiconductor elements may change their characteristics.

- (8) The internal status may be changed, if excessive external noise enters into the module. Therefore, it is necessary to take appropriate measures to suppress noise generation or to protect module from influences of noise on the system design.
- (9) We recommend you to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (10) It's pretty common to use "Screen Saver" to extend the lifetime and Don't use the same image for long time in real application. When an OLED display module is operated for a long of time with fixed pattern, an afterimage or slight contrast deviation may occur.
- (11) The limitation of FPC and Film bending.



- (12) The module should be fixed balanced into the housing, or the module may be twisted.



- (13) Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

#### 11.4. Precautions when disposing of the OLED display modules

- (1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.